



Wire Saw Cut Plates

General Product Description

Wire saw cut plates can be made from any base material and are available in round and rectangular geometry.

Due to the wire saw technology the roughness of the surface is less than Ra 0.8 μm . Also the plates have outstanding flatness and parallelism.

This cutting method produces no sub-surface damage in the material thus allowing the plates to be mechanically polished directly without a fine grinding step.

No sub-surface damage also permits firepolishing to be easily accomplished with a light flame thus minimizing warping.

A further advantage for our customers is cost effectiveness because of negligible material loss during cutting.

The thickness of the plates range from 0.675 mm to 15.85 mm.

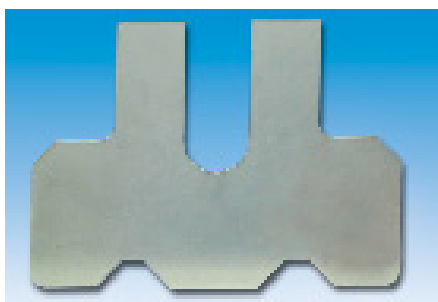
Heraeus offers wire saw cut plates in proven material qualities. These include high purity OM 100 opaque material as well as clear electrically fused materials (HSQ 300 / 700) and clear flame fused materials (HSQ 351 / 751).

More detailed information about the individual material grades are available upon request.

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Available Dimensions

Standard dimensions of plates and discs are shown in the table to the right. Other dimensions are available on request. Heraeus can offer customers the additional possibility to cut the plates to any desired shapes via water-jet or laser machining.



	Size	Thickness	Thickness Tolerance
Plates HSQ 300 / 700 / 351 / 751	up to 500 x 500 mm	2 - 10 mm	+/- 0.3 mm
Plates OM 100	up to 400 x 400 mm	3 - 6 mm	+/- 0.3 mm
Discs HSQ 300 / 700 / 351 / 751	Ø 235 - 350 mm	3 - 6 mm 2 - 6 mm	+/- 0.3 mm
Discs OM 100	Ø 235 - 355 mm	2 - 6 mm 2 - 8 mm	+/- 0.3 mm

Chemical Purities

Typical trace elements and OH-Content (ppm by weight oxide)

Elements	Al	Ca	Cr	Cu	Fe	K	Li	Mg	Mn	Na	Ti	Zr	OH Content
HSQ 300	15	0.5	< 0.05	< 0.05	0.1	0.4	0.6	0.05	< 0.05	0.3	1.1	0.7	< 30
HSQ 700	15	0.5	< 0.05	< 0.05	0.1	0.1	0.05	0.05	< 0.05	0.05	1.1	0.7	< 30
HSQ 351	15	0.6	< 0.05	0.07	0.2	0.7	0.4	0.1	0.05	0.8	1.1	1.1	175
HSQ 751	8	0.5	< 0.05	< 0.06	0.2	< 0.1	0.2	< 0.05	0.05	< 0.05	1.4	0.1	175
OM 100	15	1.2	< 0.01	< 0.05	0.2	0.4	0.6	0.05	< 0.03	0.2	1.2	0.8	-

EUROPE

**Heraeus Quarzglas
GmbH & Co. KG**
Base Materials
Reinhard-Heraeus-Ring 29
D-63801 Kleinostheim
Phone +49 (6181) 35-7444
Fax +49 (6181) 35-7210
E-Mail sales.basematerials@
heraeus-quarzglas.com

USA

Heraeus Quartz America LLC
HQI Base Materials Division
2400 Grand Avenue Parkway
Suite 102
Austin, TX 78728
Phone +1 (512) 989-05 03
Toll free 866 - 989-05 05
Fax +1 (512) 989-05 04
E-Mail sales@heraeus-quartz.com

ASIA

Shin-Etsu Quartz Prod. Co., Ltd.
Shinjuku San-Ei Bldg., 12th Floor
22-2, 1-Chome, Nishi Shinjuku
Shinjuku-Ku
Tokyo 160
Phone +81 (333) 48 19 11
Fax +81 (333) 48 49 19
E-Mail d3sales@sqp.co.jp

<http://www.heraeus-quarzglas.com>

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